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(54) **LOGIC MODULE REFRIGERATION
SYSTEM WITH CONDENSATION CONTROL**

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(52) U.S. Cl. **62/176.1; 62/259.2**

(58) Field of Search 62/259.2, 176.1,
62/93, 94, 276

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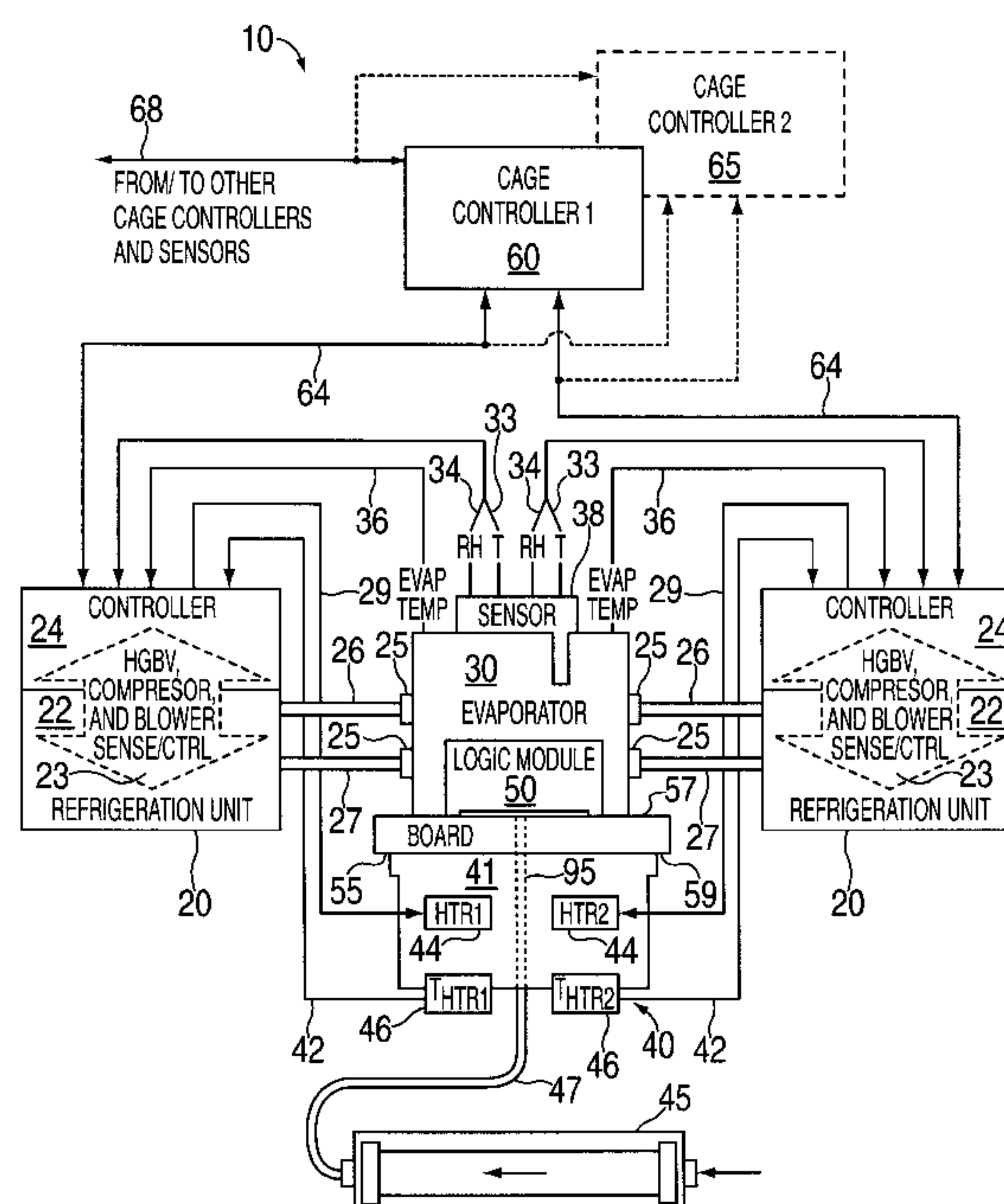
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(57) **ABSTRACT**

A refrigeration system includes an evaporator housing sealed to a first side of a circuit board containing a logic module, the evaporator housing including an evaporator block in thermal communication with the logic module. The evaporator housing further includes at least a humidity sensor for detecting a humidity within the evaporator housing. In another aspect of the invention, the refrigeration system includes a heater on a second side of the circuit board opposite the evaporator housing, the heater being in thermal communication with plated through-holes of the circuit board to maintain the circuit board above local ambient temperature. In another aspect of the invention, a source of dry pressurized air is provided into the sealed evaporator housing through a through-hole drilled directly under the logic module. In another aspect of the invention, a portion of the warm air exiting the processor cage is recirculated and caused to pass over the evaporator housing, thereby ensuring that the exterior surface of the evaporator housing is warming to above local dew point. In another aspect of the invention, two or more modular, interchangeable refrigeration units are concurrently connected to the evaporator and are controlled independently, providing backup capability to ensure the reliability of the system.

30 Claims, 7 Drawing Sheets



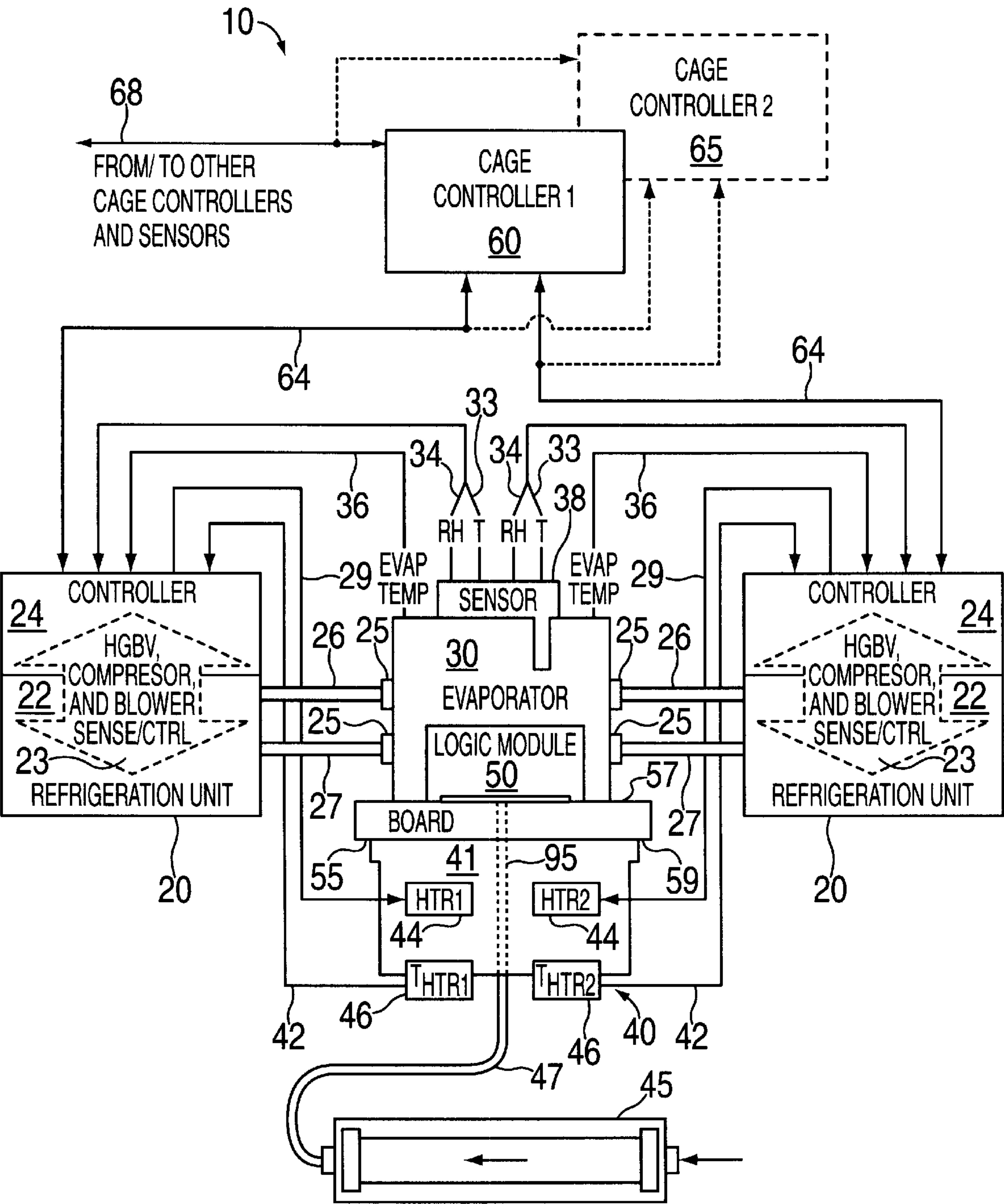


FIG. 1

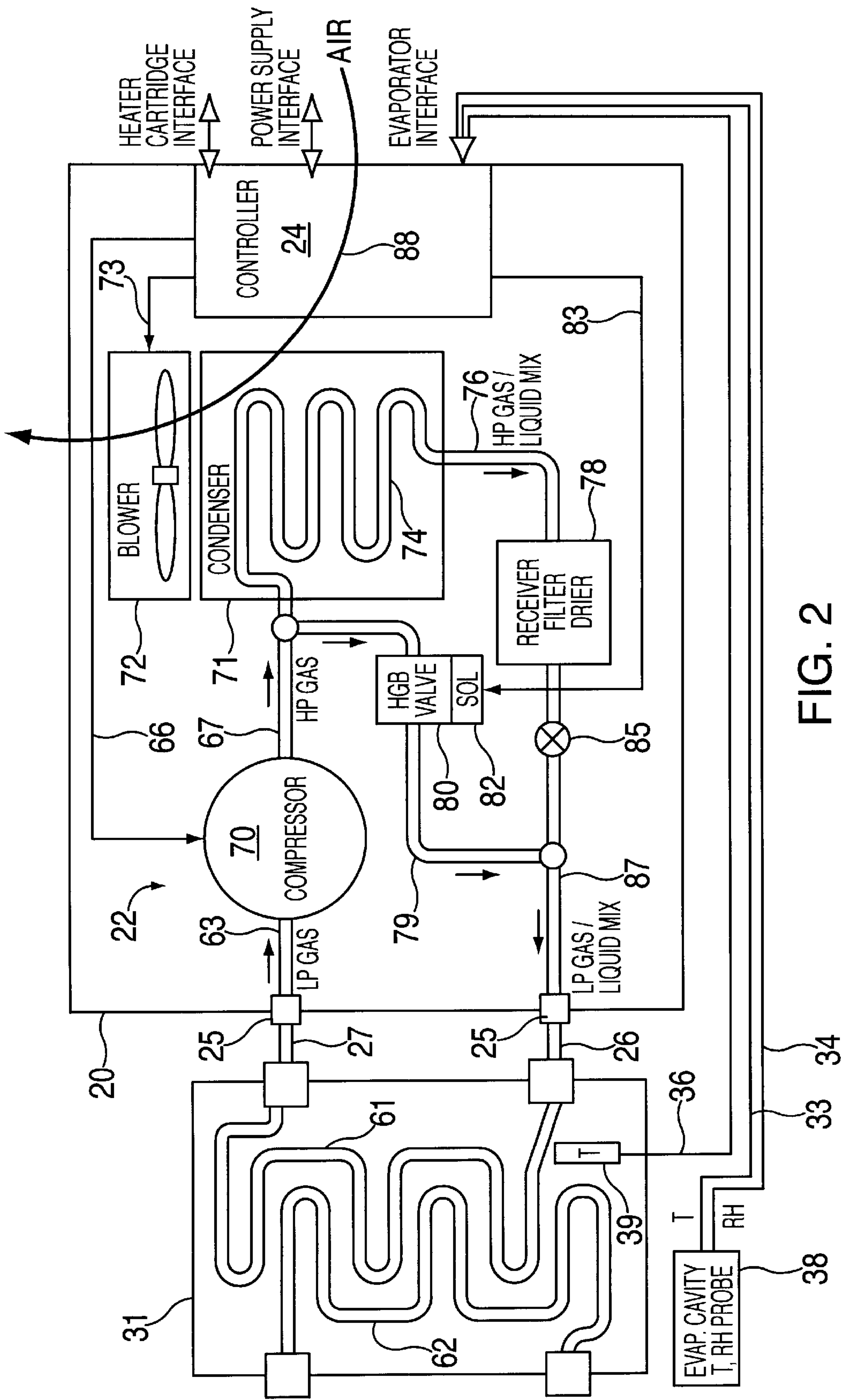


FIG. 2

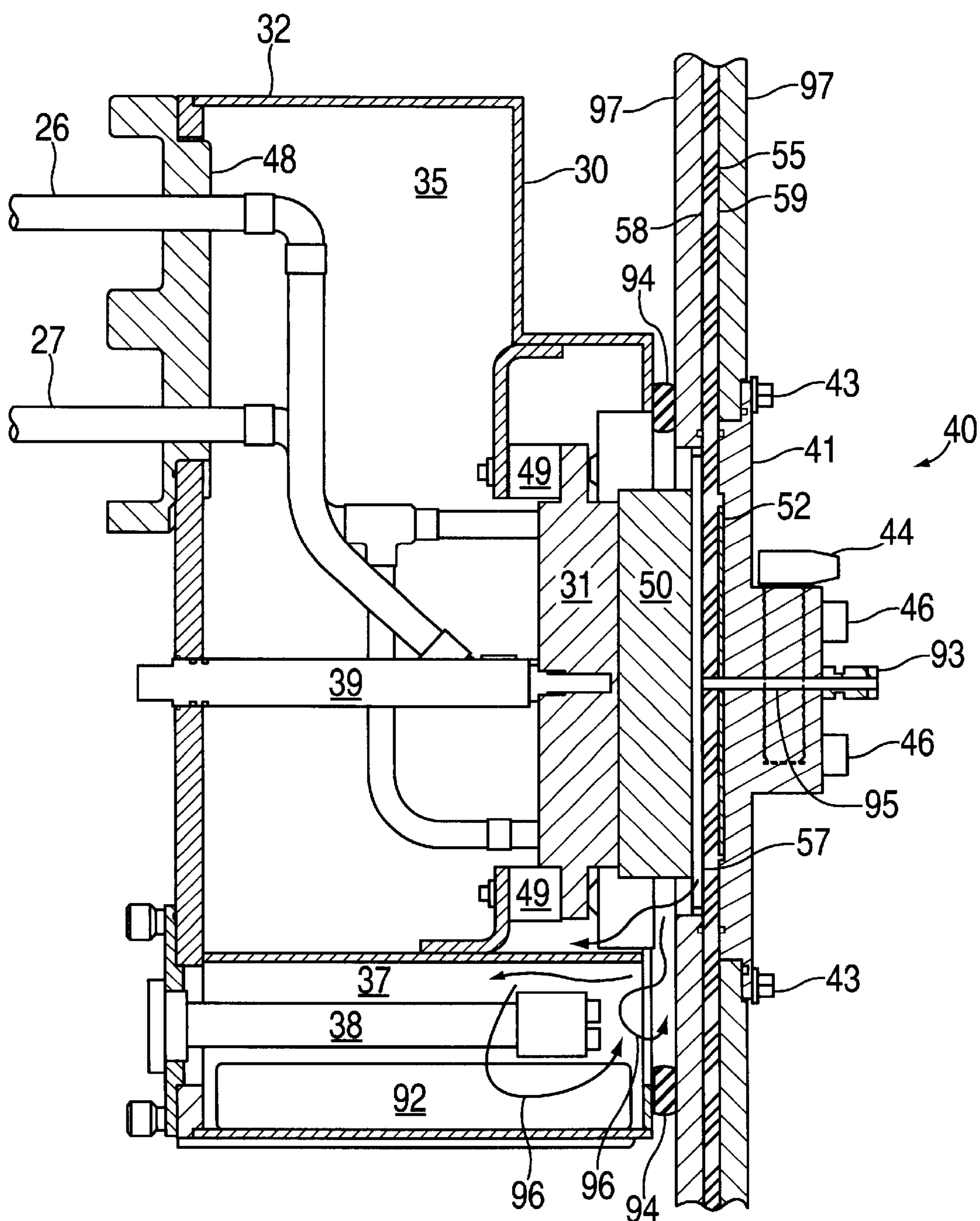
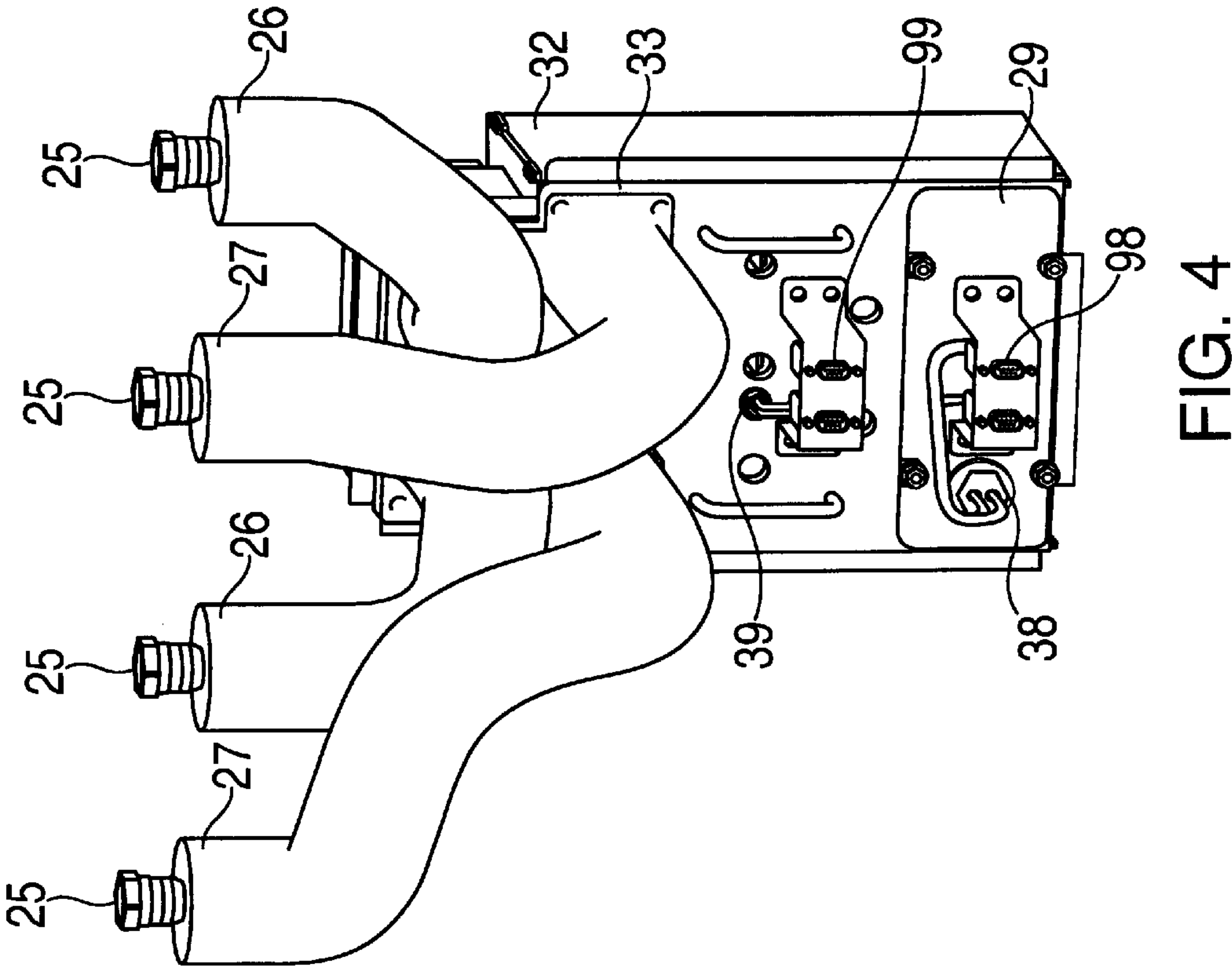
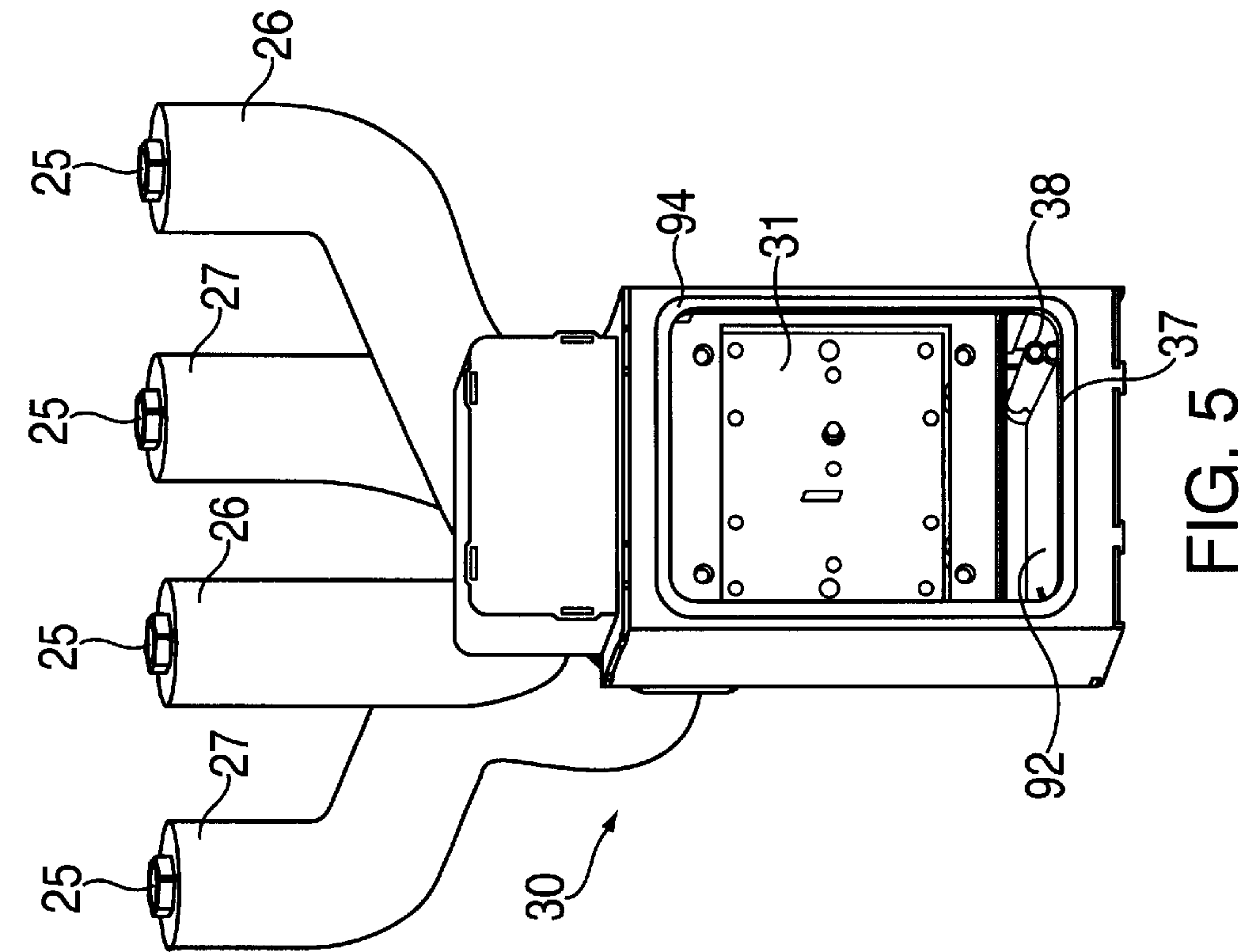


FIG. 3



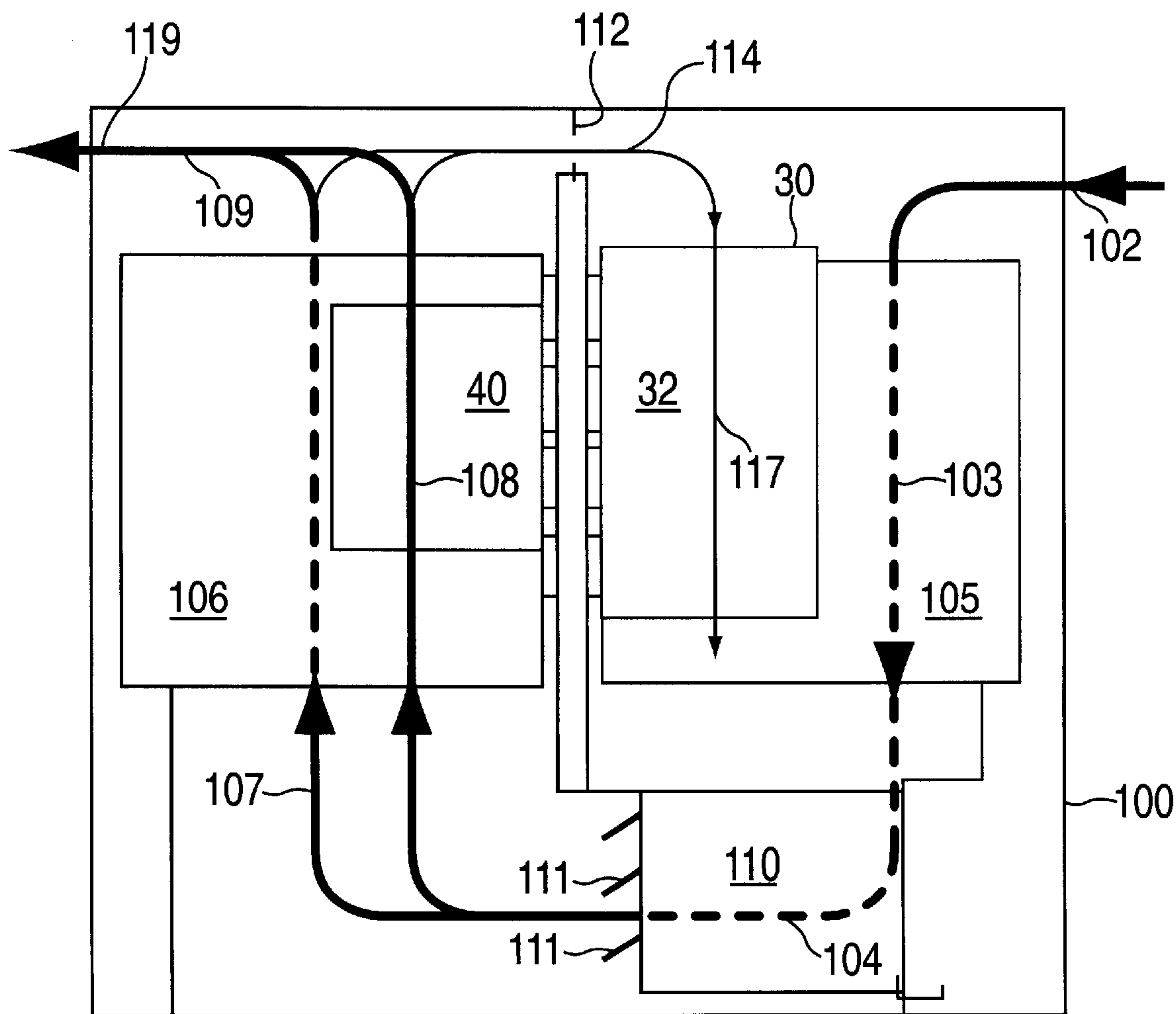


FIG. 6

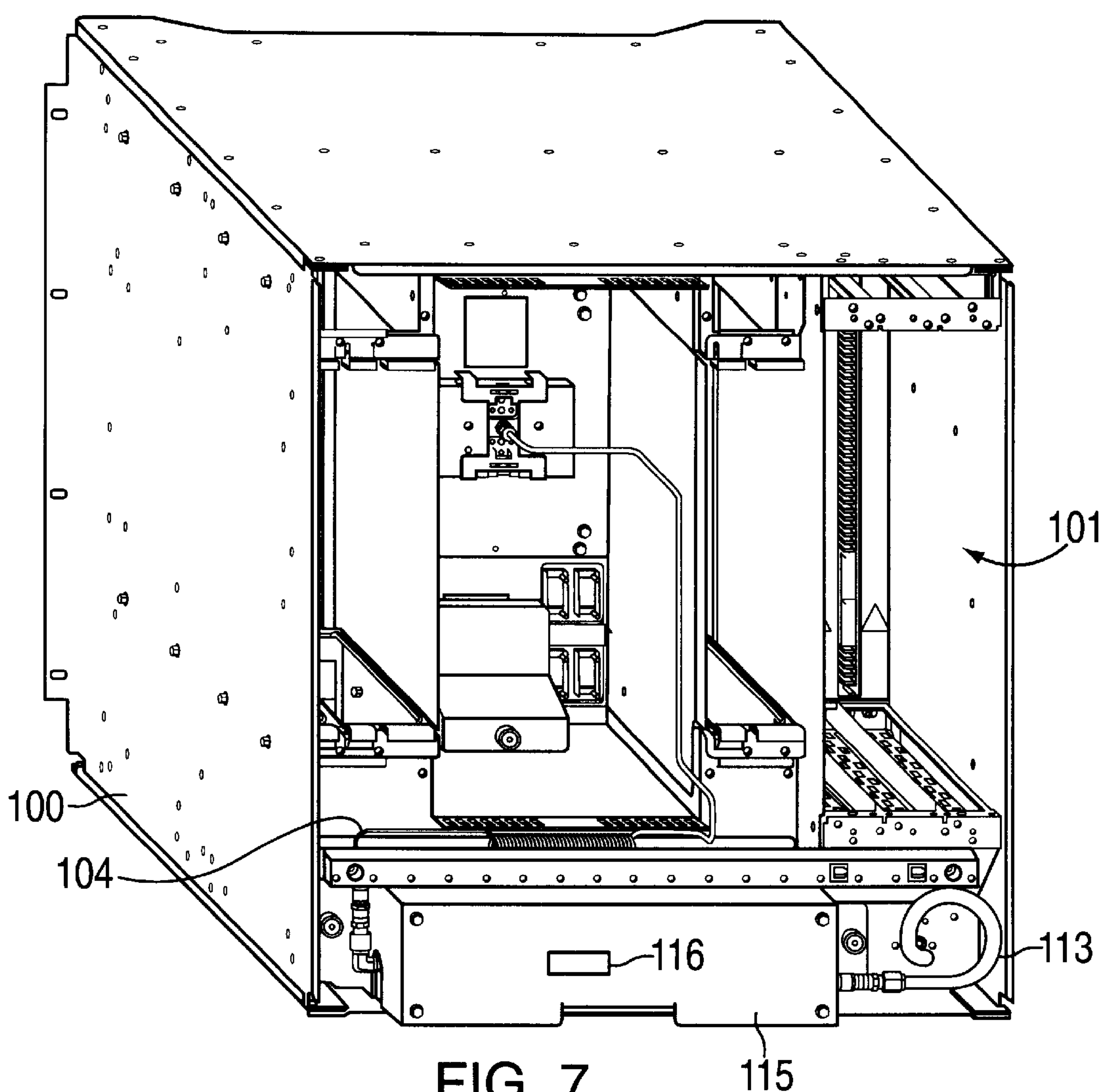


FIG. 7

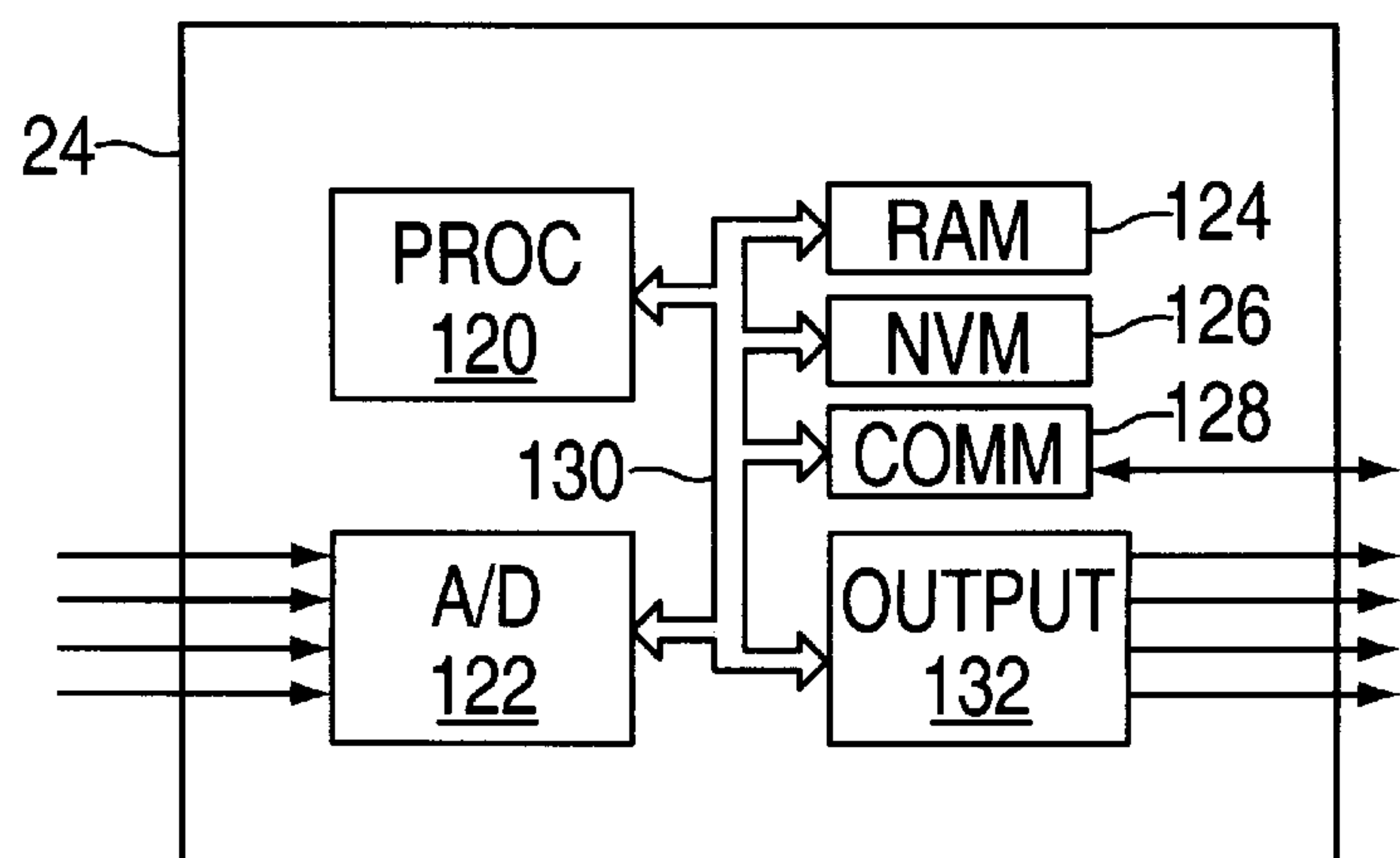


FIG. 8

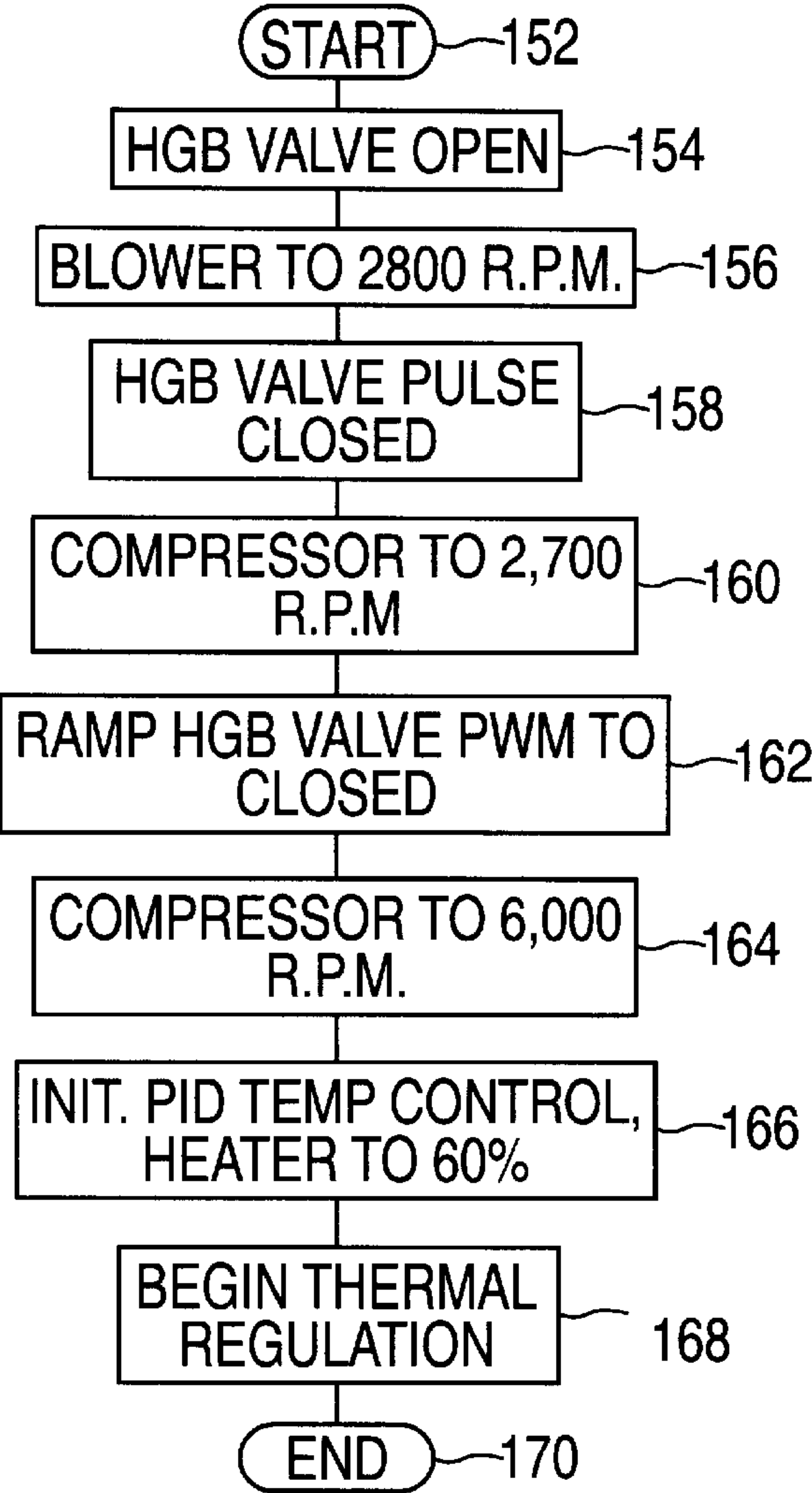


FIG. 9

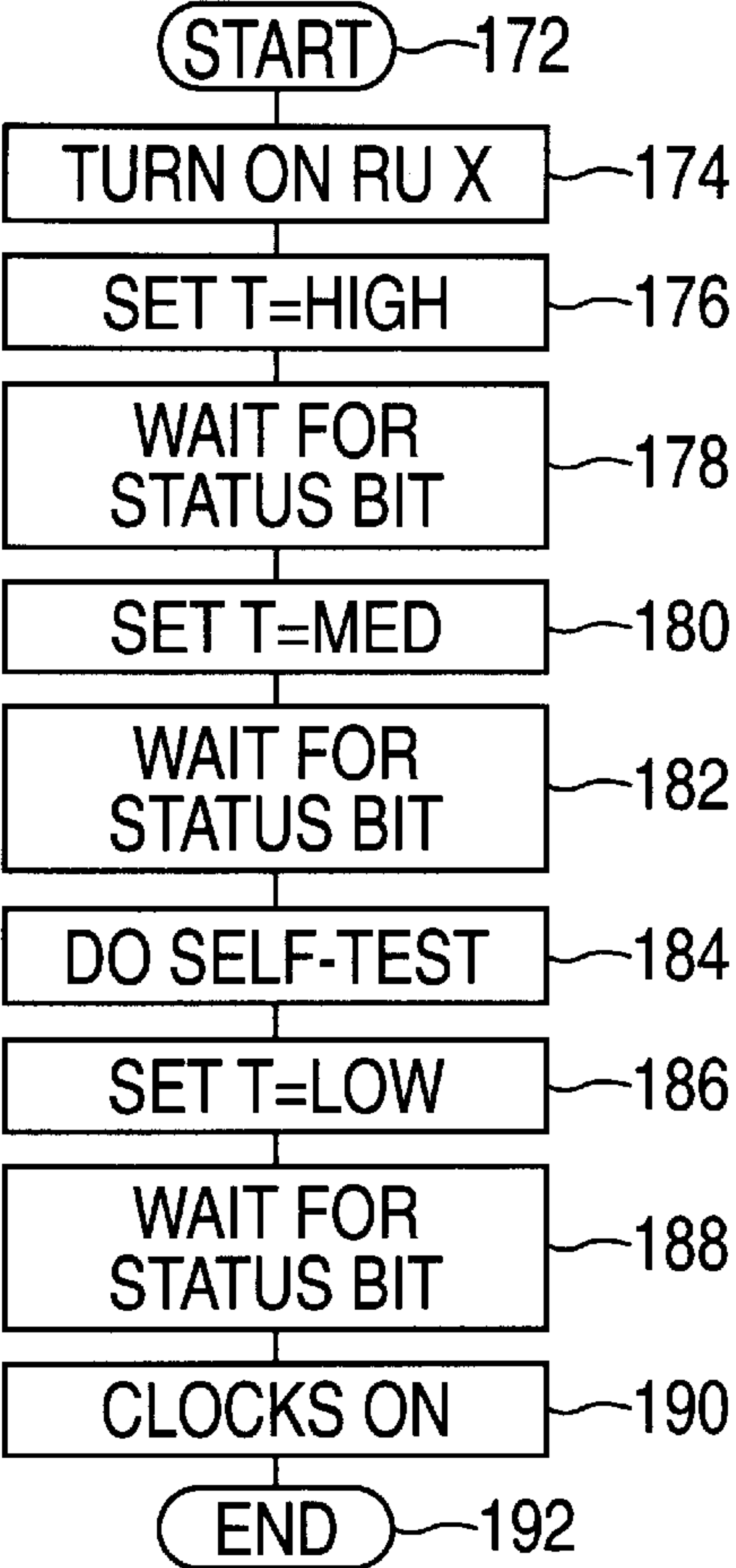


FIG. 10

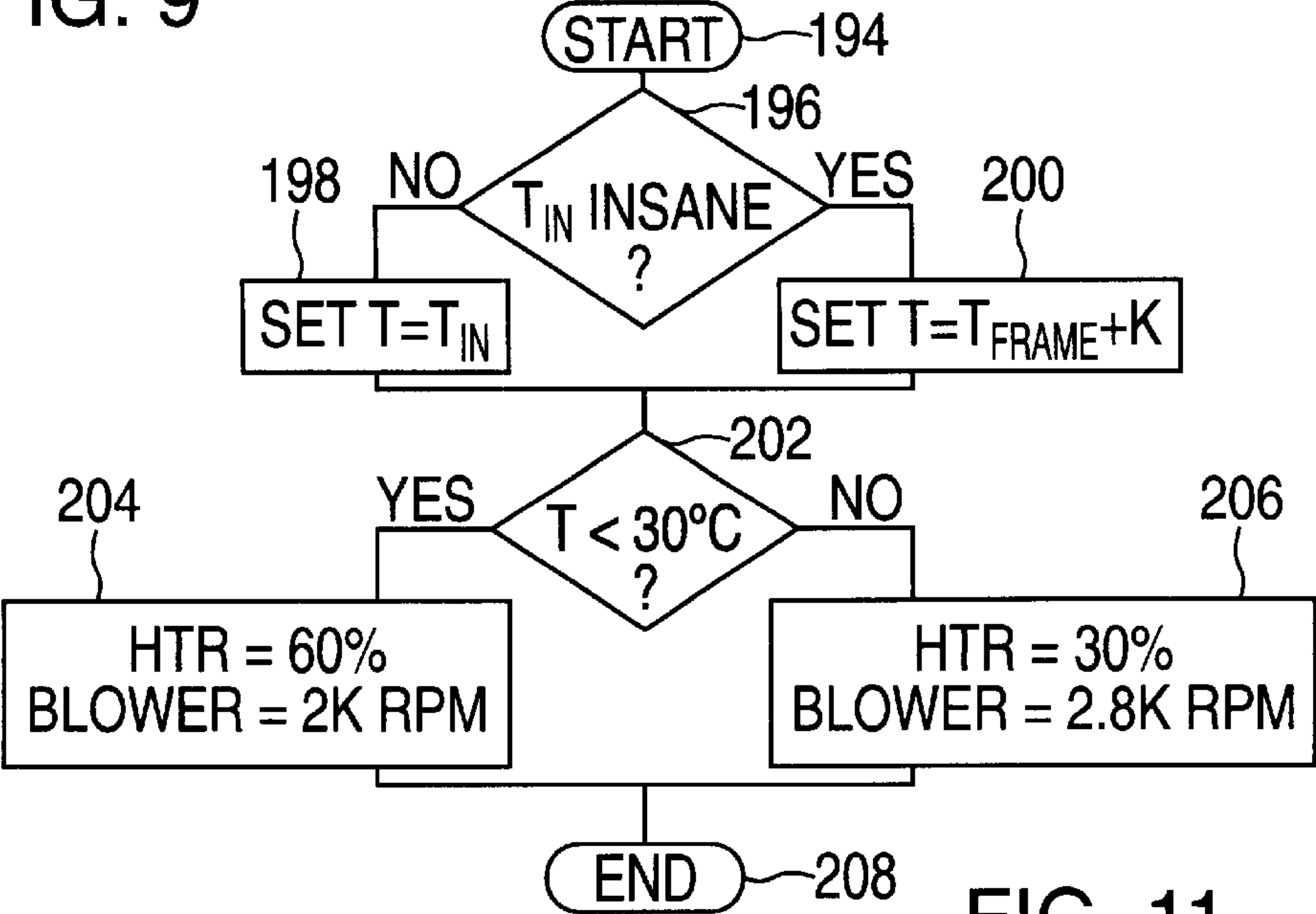


FIG. 11

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LOGIC MODULE REFRIGERATION SYSTEM WITH CONDENSATION CONTROL

BACKGROUND

The present invention relates to a cooling system and condensation control system. In particular, the present invention relates to a cooling system and condensation control system for computer logic modules.

One of the factors that limit processing speed in computer systems is the generation of excessive heat at higher clock speeds. Significant gains of speed and reliability have been achieved by cooling computer logic modules down to temperatures below ambient. Unfortunately, cooling a logic module to below ambient temperatures can result in the formation of condensation, which is undesirable in a computer system.

Prior attempts at providing a cooling system for a computer module have not been satisfactory for higher-end computing applications. For example, one approach has been to remove moisture from incoming air cooled to 5° C. This approach requires handling a tremendous amount of water, and does not prevent condensation in an application where refrigerant may be operating as cold as -40° Celsius. Another approach has been to simply apply a fixed high-power heater around an evaporator unit which surrounds the logic module. In this way, the surface temperature of the logic module housing remains above the dew point. Another approach relies on enclosing the logic module in a vacuum enclosure as a means of providing effective insulation. Unfortunately, these approaches cannot adequately ensure that there will be no condensation in the evaporator housing and are therefore not sufficiently reliable.

Another problem unresolved by prior art cooling systems relates to condensation formed on the opposite side of the circuit board. This problem has limited the temperatures to which the logic module can be cooled to avoid condensation.

SUMMARY

The above discussed and other drawbacks and deficiencies of the prior art are overcome or alleviated by a refrigeration system including an evaporator housing sealed to a first side of a circuit board containing a logic module, the evaporator housing including an evaporator block in thermal communication with the logic module. The evaporator housing further includes at least a humidity sensor for detecting a humidity within the evaporator housing. In another aspect of the invention, the refrigeration system includes a heater on a second side of the circuit board opposite the evaporator housing, the heater being in thermal communication with plated through-holes of the circuit board to maintain the circuit board above local ambient temperature. In another aspect of the invention, a source of dry pressurized air is provided into the sealed evaporator housing through a through-hole drilled directly under the logic module. In another aspect of the invention, a portion of the warm air exiting the processor cage is recirculated and caused to pass over the evaporator housing, thereby ensuring that the exterior surface of the evaporator housing is warming to above local dew point. In another aspect of the invention two or more modular, interchangeable refrigeration units are concurrently connected to the evaporator and are controlled independently, providing backup capability to ensure the reliability of the system.

BRIEF DESCRIPTION OF THE DRAWINGS

The above-discussed and other features and advantages will be made known from the following detailed description

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and accompanying drawings, wherein like elements are numbered alike, and in which:

FIG. 1 is a schematic representation of an exemplary embodiment of the hardware components of a refrigeration system;

FIG. 2 is a schematic representation of an exemplary refrigeration unit and evaporator block;

FIG. 3 is a cross-section view of an exemplary installed evaporator and heater;

FIG. 4 is a front perspective view of the evaporator of FIG. 3;

FIG. 5 is a rear perspective view of the evaporator of FIG. 3;

FIG. 6 is a schematic diagram depicting air flow management scheme in a processor cage;

FIG. 7 is a perspective view of an exemplary processor cage;

FIG. 8 schematically represents certain components of a refrigeration unit controller; and

FIGS. 9, 10, and 11 show flow charts representing certain exemplary methods for operating or controlling a refrigeration system.

DETAILED DESCRIPTION

FIG. 1 is a schematic diagram providing an overview of the hardware components of exemplary refrigeration system 10. Refrigeration system 10 includes redundant refrigeration units 20 (two are shown) that sequentially or in unison provide coolant to evaporator 30 via refrigerant lines 26. Although the cooling system will be described with reference to two refrigeration units 20, it will be understood that the invention can be adapted for use with one or more such refrigeration units. Evaporator 30 is disposed over logic module 50 and is in thermal communication therewith for cooling logic module 50 to temperatures below ambient. Heat from logic module 50 is absorbed by coolant in evaporator 30. Coolant is then passed back to refrigeration units 20 where it is compressed, condensed, and expanded in any known refrigeration cycle.

Logic module 50 is preferably a multi-chip module, as are generally known in the art, but cooling system 10 is applicable to other concentrated heat generating devices that are advantageously maintained at below ambient temperatures. Logic module 50 is electrically and mechanically attached to a first side 58 of circuit board 55. Both logic module 50 and circuit board 55 are relatively flat structures having heights that are substantially less than their widths or lengths, and are shown in FIG. 1 in profile view (i.e., disposed perpendicular to the page). To prevent condensation on a second side 59 of circuit board 55 from forming, a heater 40 is disposed on second side 59 of circuit board 55. Heater 40 includes a heat spreader plate 41 in thermal communication with circuit board 55. Thermal pads 52 (FIG. 3) enhance thermal coupling between heat spreader plate 41 and plated through-hole connections (not shown) of circuit board 55, effectively warming circuit board 55. Heater 40 further includes redundant heat cartridges 44 to provide heat to heat spreader plate 41. Each heat cartridge 44 includes a resistive heat element (not shown) for converting electrical energy into heat energy. In a preferred embodiment, each heat cartridge is rated at 300 W. In addition to heat cartridges, other heat source types, such as flat resistive heaters, are contemplated.

Each refrigeration unit 20 includes a respective controller 24 in communication with a primary cage controller 60 and

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secondary cage controller **65**, the latter being available in case of failure of primary cage controller **60**, via two-way communication lines **64**. Controller **24** operates in response to instructions from primary cage controller **60** or secondary cage controller **65** to cool logic module **50** to a desired temperature. In aid of this objective, controller **24** is equipped with various outputs and inputs to control refrigeration equipment **22** and to monitor the actual temperature of the evaporator. In addition to cooling logic module **50**, controller **24** is responsible for preventing condensation within evaporator **30** and on circuit board **55**, monitoring the temperature and relative humidity in the evaporator cavity (to be described in more detail below) and the temperature of heater **40**, to ensure that it is greater than the dew point within the processor cage (FIGS. 6, 7).

Controller **24** controls refrigeration equipment **22** within refrigeration unit **20** via signal lines **23**, and controls heat cartridge **44** via lines **29**. Evaporator plate temperature is provided via lines **36** and evaporator cavity temperature and relative humidity are provided via lines **33** and **34**, respectively. Finally, lines **42** provide heater temperature feedback.

Refrigeration units **20** are modular in nature, i.e., they are interchangeable and provide redundancy or backup capabilities to evaporator **30**. Refrigerant lines **26** and refrigerant return lines **27** are connected to refrigeration unit **20** via respective quick-disconnect couplings **25** so that either refrigeration unit **20** may be quickly swapped out for maintenance or replacement once another refrigeration unit is on line. Refrigeration units **20** each include a condenser and compressor, as is known in the refrigeration art, and passes pressurized refrigerant, which may exist as a liquid, gas, or mixed-phase fluid to evaporator **30** via refrigerant lines **26**. In a preferred embodiment, the compressor is a Maneurop LT-22 compressor, but any rotary, reciprocating, or scroll compressor of sufficient cooling capacity could be used. The precise refrigeration cycle and working fluid is determined based on a number of factors, such as the desired resultant temperature, environmental/regulatory considerations, desired coefficient of performance, desired size of condenser, cost, etc.

Referring now to FIG. 2, an exemplary cooling cycle using R507 (AZ50) refrigerant provides temperatures as cold as -40°C . and colder. As would be appreciated by those skilled in the art, the target temperature may vary with the compression ratio and other factors, including various control measures as will be hereinafter described.

In the exemplary arrangement shown, a mixture of gas and liquid refrigerant are passed to evaporator block **31** via refrigerant line **26**. Evaporator block **31** comprises copper, aluminum, or other heat conductive material and includes independent serpentine paths **61** and **62** formed therein. Serpentine paths **61** and **62** are circuitous pathways that may be formed by any known method, such as by cutting paths into a center layer that is then sealed between upper and lower layers of the material. Exemplary evaporator block structures are shown and described in commonly assigned U.S. Pat. 5,970,731 to Hare et al, issued Oct. 26, 1999 and U.S. Pat. No. 6,035,655 also to Hare et al., issued Mar. 14, 2000, both of which are herein incorporated by reference. Evaporator block **31** includes an additional serpentine path **62** for connection with a second refrigeration unit **20**. Serpentine paths **61** and **62** are separated and are not in fluid communication with each other so that one refrigeration unit **20** may be disconnected while the other continues to operate. Evaporator block **31** is disposed in thermal communication with logic module **50** within evaporator **30** (FIGS. 1, 3) so that heat from logic module **50** is readily absorbed by refrigerant in serpentine paths **61** and **62**.

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Upon absorbing heat from logic module **50** (FIG. 1) the refrigerant vaporizes and is passed back to refrigeration unit **20** via refrigerant return line **27**. This gaseous refrigerant is passed to compressor **70** via line **63**, compressed therein, and then passed to condenser **71** via line **67**, wherein it is condensed back into a liquid or mixed phase fluid. a Blower **72** is driven by a variable A.C. motor or D.C. motor and pulls air through electronic controller **24** and condenser **71** in a path generally represented by arrow **88** for absorbing the heat from the refrigerant.

After being condensed in condenser **71**, the coolant is received in filter/drier tank **78** via line **76**, then passed to expansion valve **85** where a portion of the coolant is vaporized and its temperature is reduced. The coolant is then once again made available to evaporator **30** via line **87**. A bypass line **79** is provided between lines **67** and **87** for bypassing the condenser and expansion valve in order to moderate the coolant's temperature. Bypass line **79** includes hot gas bypass valve **80**, actuated by solenoid **82**.

Controller **24** includes a processor and memory, as will be further described, for executing machine code to control the operation of refrigeration unit **20**. Control unit **24** includes various inputs for temperature and humidity sensors in evaporator **30**, to be described in more detail below, and outputs to control compressor **70**, bypass valve **80**, and blower **72** via lines **66**, **83**, and **73**, respectively. Any of lines **66**, **83**, and **73** may carry control signals for actuating a relay or motor controller (not shown) which switches on and off power to the respective component, or such relay/motor controller may be internal to controller **24**, and lines **66**, **73**, and **83** carry power to the respective components, in the known manner. The power supply and power lines are not illustrated for sake of clarity.

Additionally, refrigeration unit **20** includes outputs for controlling heat cartridge **44** (FIGS. 1, 3) and an input for receiving electrical power for supplying energy to controller **24**, as well as compressor **51**, blower **61**, and solenoid **82**.

FIG. 3 shows a cross section view of an exemplary implementation of an evaporator **30** and heater **40** assembled with a logic module **50** and circuit board **55**. Circuit board **55** is provided with stiffeners **97** on either side to aid in supporting and attaching evaporator **30** and heater **40** to circuit board **55**. Evaporator **30** is attached to a first side **58** of circuit board **55** and heater **40** is attached to a second side of circuit board **55** by screws **43** connected to stiffener **97** as shown. Refrigerant line **26** and refrigerant return line **27** supplies one of two serpentine paths **61** and **62** (FIG. 2). A second pair of refrigerant and refrigerant return lines lie directly behind lines **26** and **27** shown, allowing connection to an additional refrigeration unit **20**, as described above.

Refrigerant line **26** and refrigerant return line **27** are connected to evaporator block **31** which is in thermal communication with logic module **50**. Evaporator block and logic module **50** are sealed in an evaporator housing **32** by gasket **94**. After assembly, Evaporator cavity **35** is filled with insulation, such as an injected polymer foam insulation, to reduce the amount of heat absorbed from evaporator housing **32**, thus preventing the temperature of evaporator housing **32** from dropping below dew point. Grommet **48** is formed of insulating material and includes holes for passing refrigerant lines **26** and refrigerant return lines **27** into evaporator housing **32**. Also extending into housing **32** is evaporator block temperature probe **39**, which includes a sensor extending into evaporator block **31** for detecting the temperature of the evaporator block, and providing feedback information to refrigeration units **20** as previously described. Evaporator

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block temperature probe 39 preferably comprises dual thermistors for providing independent temperature detection for each of two refrigeration units 20. Evaporator housing 32 is attached to circuit board 55 in the known manner, with evaporator block 31 being biased against logic module 50 using biasing elements 49, which may comprise metal springs or elastomeric blocks.

Heater 40 comprises heat spreader plate 41 which includes accommodations for two heat cartridges 44 and dual temperature sensors 46 for detecting the temperature of heat spreader plate 41 and providing feedback to respective refrigeration units 20.

The internal atmosphere of evaporator 30 will be described with reference now to FIGS. 1 and 3. Desiccant canister 45 is connected at its inlet to a source of pressurized air. Dry air flows out of desiccant canister 45 through capillary tube 47 to heat spreader plate 41. Heat spreader plate 41 and circuit board 55 include an aligned through-hole 95 for conducting dry air from said capillary tube to the first side 58 of circuit board 55. Logic module 50 comprises a zero-insertion force connector as is known in the art which includes a small air space 57 (FIG. 3) between logic module 50 and circuit board 55. This arrangement raises the air pressure in evaporator housing 32 to slightly above ambient. Thus, any small amount of leakage or diffusion will only result in dry air infiltrating into evaporator housing 32.

Evaporator 30 also includes a desiccant slot 37 housing a desiccant bag 92 which absorbs any remaining moisture in evaporator cavity 35, such as might occur upon replacement or servicing of dual humidity and temperature sensor 38. Arrows 96 shows free movement of air between evaporator cavity 35 and desiccant slot 37. Desiccant slot 37 also houses dual humidity and temperature sensor 38, which includes redundant humidity and temperatures sensors. In a preferred embodiment, humidity and temperature sensor is or is similar to one available from Honeywell, part number HHH-3602-C and includes two independent humidity sensors and two independent thermistors. Capillary tube 47 is sufficiently long or otherwise includes an airflow resistor, such as an orifice, to prevent excessive air flow through capillary tube 47 in the case of a leak or while dual humidity and temperature sensor 38 is being serviced or replaced.

FIGS. 4 and 5 show front and rear perspective views of evaporator 30, respectively. Refrigerant lines 26 and refrigerant return lines 27 are surrounded with thermal insulation to prevent condensation and loss of efficiency. Desiccant slot cover 28 (FIG. 4) encloses desiccant slot 37 and supports "D" connectors 98 which connect dual humidity and temperature sensor 38 to respective refrigeration units 20. Similarly, "D" connectors 99 are provided to connect evaporation block temperature sensor 39 to respective refrigeration units 20.

FIG. 6 shows a schematic representation of airflow management within processor cage 100. Air is drawn into processor cage 100 at air inlet 102. Air flows past memory books 105 and redundant power supplies (not shown) along path 103. Air is then forced through one of a plurality of blowers 110 (only one shown). Blower 110 includes louvers 11 which operate as check valves to prevent back flow through blower 110 when fewer than all blowers are operating. Air flows generally along path 107 by memory books 106 and along path 108 by heater 40. A majority of this air exits at exit 119, however some air flows through orifice 112 and then past evaporator 30 and then recirculates through one or more of blowers 110. In this manner, evaporator housing 32 is warmed by air previously warmed by absorb-

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ing heat from the power supply (not shown), memory books 105, 106, blowers 110, and heater 40. This warmed air passes heat energy to evaporator housing 32, thereby increasing its surface temperature to above dew point, ensuring that no condensation will form thereon.

FIG. 7 shows a perspective view of cage controller 100. A source of pressurized air supplies air through air hose 113 to desiccant canister 45 (FIG. 1) which resides in canister housing 115. A view-window 116 is provided so that an operator can see when the desiccant changes color, indicating saturation. Canister housing 115 outputs dry air to capillary tube 104 which is sufficiently long to restrict the air flow as previously described. Capillary tube 104 feeds into heat spreader plate 41 as shown. Cavity 101 receives modular redundant power supplies which provide power to logic module 50 (FIG. 1).

Referring to FIG. 8, each refrigeration unit controller 24 includes a processor 120, an analog-to-digital converter 122, random access memory 124, non-volatile memory 126, communication port 128, and output 132. Controller 24 also includes other necessary ancillary components such as power supply, clock, etc., which are not shown for sake of clarity. Non-volatile memory 126 may be any type of machine readable media such as ROM, PROM, EPROM, EEPROM, Flash, magnetic media, optical media, or other known type of non-volatile memory. Communications port 128 is preferably a standard serial port, as are generally known in the industry, such as the RS422 serial port. Each of these components are in communication with processor 120 via one or more data busses 130 (only one shown).

During operation of controller 24, software stored in non-volatile memory 126 causes processor 120 to perform various operations on input and to generate outputs accordingly. As shown in FIG. 1, controllers 24 are in communication with primary and secondary cage controllers 60 and 65. Additionally, cage controllers 60 and 65, which are also intelligent devices, are in communication with other controllers and sensors via Ethernet (see line 68 in FIG. 1) as generally known and understood in the art. Cage controllers 60 and 65 are responsible for monitoring and regulating the power supply, cooling fans, internal processor cage temperature, and other environmental aspects of the processor cage to ensure proper functioning of the system and the various internal components.

The use of an intelligent refrigeration unit controller allows the refrigeration unit to cooperate with the cage controller and larger system to maximize the performance of the logic module without sacrificing reliability. In this regard the controller can, in response to instructions from cage controller 60, precisely control the temperature of the evaporation block by controlling the speed of compressor 70 and by actuating hot gas bypass valve 80 (FIG. 2) in response to temperature readings from evaporator block temperature probe 39. The temperature to which the evaporator block is controlled may vary according to the current condition or operation of the logic module operating mode or power consumption, as well as the expected condition or operation of the logic module. In addition, the refrigeration unit controller is capable of reacting to component failures and notifying the cage controller of such failures. This provides improved reliability by allowing the cage controller to then switch to a second refrigeration unit and alert system administrators of the failure for repair or replacement of the defective component and/or refrigeration unit. Furthermore, by integrating the refrigeration unit with the cage controller, smooth transitions from one refrigeration unit to another can be easily achieved.

TABLE 1

SYSTEM	RU 1	RU 2
N mode	On	Off
N+1 mode	On	Deactivated
Switchover mode	Switchover from	Switchover-to

The system and the individual refrigeration units are capable of entering several different modes of operation to accomplish this task as summarized by Table 1. These modes will now be described with reference to an exemplary system capable of being connected to only two refrigeration units at any one time, though it should be understood that the system may be adapted to accommodate any number of refrigeration A units. In the “N-mode,” one refrigeration unit is on while the other refrigeration unit is either off or deactivated. When in the off-mode, the refrigeration unit is not operating to cool the logic module, but it is actively communicating with cage controller 60. When in the deactivated-mode, the refrigeration unit is off-line or disconnected. In the N+1 mode, the first refrigeration unit is on, while the second is “enabled”. In the enabled mode, a refrigeration unit is not functioning to cool the logic module, and it is in communication with cage controller 60. What distinguishes “enabled” from “off” is that when enabled, the refrigeration unit is ready to step in and turn on, by itself and without instruction from the cage controller, if necessary. The conditions under which an enabled refrigeration unit may turn on by itself include sensing evaporator over-temperature and the cage controller didn’t turn it on. A third mode of the system is the “switchover” mode. In a switchover mode, one refrigeration unit is designated the “switchover-from” unit, indicating that it is in a shut-down sequence, and one refrigeration unit is in a “switchover-to” mode, indicating that it is in a start-up sequence. The shutdown and startup sequences vary depending on whether the switchover-from unit is experiencing a fatal error or whether the switchover-from unit is running normally or experiencing only a minor error. A minor error is one that can be compensated, an example of which will be described below with reference to FIG. 11.

Each controller 24 makes status data available to the cage controller 60, and the cage controller 60 periodically transmits status data and instructions to the refrigeration unit controllers 24. This periodic data transmission is called “stuffage” and allows the refrigeration units to react to failures of the cage controllers, while the cage controllers’ monitoring of refrigeration unit data allows them to react to failures of the refrigeration units in a logical manner. In the exemplary embodiment, refrigeration unit controller 24 sends posts the value of all the sensors of the refrigeration unit, particularly the evaporator and heater block temperatures, flags indicating the mode the refrigeration unit is currently in, and fault data, such as evaporator cavity over-humidity, heater block over-temperature, etc. This information is available to the cage controller to read. Every 7 seconds or so, the cage controller 60 stuffs the refrigeration unit with data including the current power of the logic module, ambient temperature, control commands such as turn on/off, prepare for power on, prepare for self test, enter enable mode, enter/exit switch-over-to mode, enter/exit switch-over-from mode, fault flags control commands to set or clear fault flags in the refrigeration unit controller.

During operation, cage controller 60 determines the set point for the refrigeration units. The set point is the desired

temperature of evaporator block, and is dependent on the requirements of the logic module and the mode of operation and power draw of the logic module. For example, during start up operation, the set point is initially set to a high temperature of, e.g., 0° C. which may be designated a standby temperature. During self-test or periods of low current draw, the set point is set to an intermediate temperature to avoid condensation, e.g., -10° C. During normal operation, the set point is set to a low temperature, e.g., -20° C. It may be necessary to raise the set point during periods of low power dissipation in the logic module to ensure the surface temperature of the portion of the circuit board outside the sealed environment does not rise above the dew point.

FIG. 9 provides a flow chart diagram describing an exemplary start-up sequence. This represents code in refrigeration unit controller 24 and is particularly directed towards starting up the compressor without drawing excessive current from the power supply. The procedure begins at start block 152 and proceeds immediately to block 154 which instructs the hot gas bypass valve 80 (FIG. 2) to open to unload the compressor. Compressor 70 (FIG. 2) is driven to a relatively slow speed of about 2700 r.p.m. The hot gas bypass valve 80 is then pulsed by opening, closing, then opening again, to ensure that it is functioning properly. By employing pulse width modulation, the hot gas bypass valve is ramped to 100% closed at block 162. At about 81 seconds from start-up, the compressor speed is advanced to 50 Hz, which is equivalent to 3000 rpm at block 164. In block 166 PID (proportional, integral, derivative) control of the evaporator block temperature then begins at about 86 seconds after startup and the heater is powered to 60% on (e.g., using pulse width modulation with about 2 second cycle time). Block 168 begins thermal regulation and at block 170, the logic thread terminates.

The cage controller prepares for changes in logic state and sets the set point prior to the change, but not for so long as to create condensation. For example, in order for the logic module to function at optimum cycle time, it should already be chilled to its planned temperature condition. Therefore, the logic code must first request a low temperature state, then wait for the cage controller and refrigeration unit to provide that state, e.g., by changing the set point. Once the set point is achieved, the refrigeration unit sets a status bit for the cage controller to read, thus indicating that it has achieved status. The status bit may be indicative of an evaporator block temperature being within a selected range, e.g., 2° C. or 5° C., of the set point. Once the cage controller notices that the status bit is set, it gives permission to the logic code to operate at the faster cycle time. If the cage controller or refrigeration unit notices that the logic module failed to increase its cycle time within a selected time frame, e.g., anywhere from 20 seconds to 2 minutes, it will reset the set point to the high or medium temperature, to avoid condensation.

FIG. 10 represents code in cage controller 60 that is executed prior to “clocks-on” mode, i.e., prior to running logic module at its optimum speed. This procedure begins with block 172 and proceeds immediately to block 174 wherein one of refrigeration units 20 is turned on. The unit to be turned on may be selected at random, or otherwise. At block 176, the set point temperature T is initially set to high, which may correspond to 0° C. At block 178, cage controller 60 then waits for the status bit in refrigeration unit 20 as described above. If all is well, cage controller 60 sets the set point to a medium value, e.g., -10° C. as block 180 provides. At block 182, cage controller 60 then waits once again for

the status bit in refrigeration unit **20**. At block **184**, with the logic module cooled to its intermediate value, cage controller **60** signals higher-level code to commence its self test. This step may be skipped at the user's option. If all is well, cage controller continues to block **186** where the set point is finally set to the low temperature, e.g., -20°C . At block **188**, cage controller **60** again waits for the status bit. Then, at block **190**, cage controller gives the higher-level code the go-ahead for clocks-on, and the procedure terminates at block **192**. If clocks-on fails to commence within a selected time-frame, e.g., 2 minutes, then the set point is returned to the intermediate value to prevent over-cooling of the circuit board.

Each refrigeration unit controller **24** monitors its individual humidity sensor or its independent output of dual humidity and temperature sensor **38** to ensure that it remains within normal limits. If the sensor output is outside the normal limits of the sensor probe, controller **24** sets an error flag indicating that the sensor is "insane". Higher level system code monitors the error flags from refrigerator unit **20**. Upon detecting the error, the higher level system code will message a system operator that the humidity sensor needs to be replaced, as described below.

Sometimes, a humidity sensor will slowly drift from the correct reading, rather than returning an insane value. To detect a faulty sensor that is merely inaccurate, rather than insane, cage controller **60** compares the actual sensor values together when one of refrigeration units **20** indicates an over humidity condition. If the difference between the readings is beyond a miscompare limit, e.g., 5% relative humidity, the higher-reading humidity sensor is flagged as defective and the operator is requested to replace the dual humidity and temperature sensor **38**. If the difference between the readings is within the miscompare limit, then a dry air breach warning is surfaced and a repair is requested of this condition. In an alternate embodiment, dual humidity and temperature sensor **38** is replaced with a pressure sensor. This would protect against failures of the seal around evaporator cavity **35**, but would not insure against moisture diffusion through the various elastomeric membranes.

It should be noted that the output of the thermistors in dual humidity and temperature sensor **38** are used to correct the sensed relative humidity value for evaporator cavity **35** in accordance with the manufacturer's specifications. It is this temperature-corrected relative humidity value that is used for fault detection and isolation. The correction is required since the local air temperature around dual humidity and temperature sensor **38** varies with ambient as well as with the temperature set point in evaporator **30**.

Concurrent maintenance, i.e., maintenance during continued operation of the logic module, of the dual humidity and temperature sensor **38** (humidity sensor) is accomplished by deactivating the humidity sensor. In this case, "deactivating" the humidity sensor means causing heat cartridge **44** to thermostatically control the board temperature to a higher than normal value to prevent moisture from forming thereon when evaporator cavity **35** is opened for the short time needed to replace humidity sensor **38**. Refrigeration unit controller **24** sets a timer when the humidity sensor is deactivated and gives a warning signal if the repair procedure takes too long. For example, if the evaporator cavity is opened for more than 10 minutes, an audible alarm is produced, or a warning message is sent to cage controller **60**. If the amount of dry air supplied from desiccant canister **45** is increased while evaporator cavity **35** is opened, then this time may be increased. For example, capillary tube **47** may be replaced with a pair of differently-sized orifices, with a

valve and actuating mechanism, to allow increased air flow while the humidity sensor is being serviced.

While dual humidity and temperature sensor **38** is being replaced, the internal desiccant bag is also replaced so that any moisture that enters evaporator cavity **35** during this procedure is removed. Once dual humidity and temperature sensor **38** is replaced, it is "activated" and the heaters are returned to normal power. Refrigeration unit **20** then resumes normal monitoring of the relative humidity levels in evaporator cavity **35**.

Temperature sensors **46** are monitored for sanity in a manner similar to the way the humidity sensors are monitored. For example, if the heaters are more than 10°C . apart in their temperature measurements, a miscompare fault flag is set, and one or both sensors are replaced.

Outputs of temperature sensors **46** are also compared with over and under temperature limits. These limits are a function of other system states or environmental conditions. A temperature outside the range defined by the over and under limits, could indicate a faulty heater, connection, or drive circuit. A defect in the running refrigeration unit triggers a switchover to the other (good) refrigeration unit. The defective heat cartridge and thermistor is concurrently replaced by first deactivating the heater, causing the good running refrigeration unit to thermostatically control the heater to a lower, touchable temperature. As with the humidity sensor, a timer is set as a result of the heater deactivating command. Sufficient time is allotted for replacing heat cartridge **44** and thermistor **46**, but not so much time as to permit moisture to form on critical surfaces. For example, the timer may be set for 10 minutes, after which an alarm sounds.

Each refrigeration unit **20** controls its own heat cartridge **44**, and the heat value is controlled from no heat to full heat, up to 300 W, if heat cartridge **44** is a 300 W heater. Heat cartridge **44** is controlled by pulse width modulation at a frequency fast enough compared to the thermal mass of heat cartridge **44** that prevents temperature cycling and related heater failure, e.g., 2 Hz has been found to be a sufficiently fast frequency. Unique heat values are used for particular power and environmental states. In a method described by FIG. 11, the heater power is reduced for high ambient air temperature conditions. Ambient temperature is measured within the refrigeration unit enclosure at the inlet to condenser **71** (FIG. 2) using a thermistor. This thermistor is tested for sanity in the same manner as temperature sensor **46** described above. Starting with block **194** refrigeration unit controller **24** proceeds immediately to block **196** and determines whether the thermistor at the inlet of condenser **71** is insane. If not, controller **24** proceeds to block **198** wherein the condenser inlet temperature is taken as the ambient temperature, and controller **24** proceeds to block **202**. If the thermistor is insane, then the ambient temperature is set to the ambient temperature from a thermistor mounted on the system frame, which is provided in stuffage from cage controller **60**. A compensation value is added to this value since the frame temperature will typically be several degrees cooler than the air entering condenser **71**, due to the environment in refrigeration unit **20**. Controller **24** then proceeds to block **202**.

At block **202**, controller **24** tests whether the ambient temperature is less than 30°C . If so, heat cartridge **44** is set to 60% of maximum and blower **72** (FIG. 2) is set to 2,000 rpm. Then, the procedure terminates at block **208**. If the ambient temperature is greater than 30°C ., the heat cartridge is set to only 30% of maximum and the blower is set to 2,800 rpm, to compensate for warmer ambient air.

Switchover from one refrigeration unit **20** to another refrigeration unit **20** can occur on a scheduled basis, for example, every 160 hours. In addition, switchover can be for recovery purposes, i.e., when one refrigeration unit is faulty. In particular, a recovery switchover may be in response to such failures as double communications fault to the on refrigeration unit, temperature sensor **46** insane, over temperature, or under temperature, or dual humidity and temperature sensor insane or over humidity. A double communication fault occurs when both cage controller **60** and secondary cage controller **65** lose communication with the on refrigeration unit.

In a switch-over mode, cage controller **60** posts switching-from and switching-to bits in stuffage to respective refrigeration units **20**, then posts a “switchover” function bit. The switching-from refrigeration unit compressor is set to maximum speed and its hot gas bypass valve is closed (0%) to prepare for turning on the switching-to refrigeration unit. After a short pause, the switching-to refrigeration unit is turned on, causing significant heat to be passed to evaporator block **31** during startup. The switching-to unit set point is then set a small amount lower (e.g., 1° C.) than the set point of the switching-from refrigeration unit, causing the switching-to unit to be taxed to a greater extent as the switching-from unit dumps heat through its hot gas bypass valve in an effort to bring the temperature up to its set point. Switching-to and switching-from refrigeration units are designed to be capable of maintaining this “switch-over” mode indefinitely. However, the switching-from refrigeration unit is kept on for a selected period of time, e.g., 4 minutes. The switching-from refrigeration unit is then turned off only after the switching-to unit exhibits no fault or warning conditions. After good status, the cage controller shuts down the switching-from refrigeration unit, and places it in enabled mode, then clears the switchover mode and function bit.

In the case of a recovery switchover, there is no pause in bringing the switching-to refrigeration unit to the set point temperature, and once achieved, the switching from refrigeration unit is immediately shut down.

When a system is powered off after the logic module has been chilled to below zero, there is a danger that condensation will form when the evaporator is removed to service the logic module. To prevent such condensation from forming, cage controller **60** sends the running refrigeration unit **20** a “prepare-for-power-off” command, causing it to open its hot gas bypass valve **80**, causing high enthalpy refrigerant to pass directly into the evaporator and thus rapidly heating the evaporator, as well as the logic module it is attached to. To further accelerate the heating of the chilled logic unit and circuit board, heat cartridge **44** is left on. These steps enable logic module **50** to be serviced in an acceptable timeframe without danger of condensation being formed on the vulnerable areas.

While the invention has been described with reference to specific embodiments thereof, it is intended that all matter contained in the above description and shown in the accompanying drawings be interpreted as illustrative and not limiting in nature. Various modifications of the disclosed embodiments, as well as other embodiments of the invention, will be apparent to those skilled in the art upon reference to this description, or may be made without departing from the spirit and scope of the invention as defined in the appended claims.

We claim:

1. A refrigeration system for cooling a logic module mounted to a circuit board, the system comprising:
 - an evaporator housing enclosing said logic module and sealed to said circuit board;
 - an evaporator block inside said evaporator housing in thermal communication with the logic module; and

a humidity sensor disposed within said evaporator housing for detecting a relative humidity of air inside said evaporator housing.

2. The refrigeration system of claim 1, wherein:

said evaporator housing further comprising a refrigeration unit supplying expanded refrigerant to the evaporator block through a wall in the evaporator housing via a refrigerant line and a refrigerant return line.

3. The refrigeration system of claim 2, said refrigerant and refrigerant return lines including quick-disconnect connections, allowing the refrigeration unit to be easily disconnected from said evaporator housing.

4. The refrigeration system of claim 2 further comprising an additional refrigeration unit, the evaporator block having a distinct path for each refrigeration unit.

5. The refrigeration system of claim 1 further comprising a heater on a second side of the circuit board opposite the logic module, the heater being in thermal communication with plated through holes of the circuit board.

6. The refrigeration system of claim 5 wherein the heater comprises a heat spreader plate in thermal communication with the plated through holes of the circuit board, a heat source in thermal communication with the heat spreader plate, and a temperature sensor sensing the temperature of the heat plate.

7. The refrigeration system of claim 6 wherein the heat source comprises a heat cartridge disposed in a recess of the heat spreader plate.

8. The refrigeration system of claim 6 wherein the heater includes two independent heat sources, each capable of providing sufficient heat to the circuit board such that no part of the circuit board that extends outside the evaporator housing is permitted to cool to a temperature below the local dew point.

9. The refrigeration system of claim 6 wherein the heater includes a through-hole perpendicular to a plane in which the circuit board is disposed, the through-hole being aligned with a through-hole in the circuit board and positioned directly under the logic module, the system further comprising:

- a source of dry pressurized air; and
- an air line extending from said source of dry pressurized air to said through-hole.

10. The refrigeration system of claim 9 wherein said source of dry pressurized air includes a source of pressurized air providing pressurized air to a desiccant canister, the desiccant canister containing desiccant for absorbing moisture in the air.

11. The refrigeration system of claim 9 wherein the air line comprises a capillary tube.

12. The refrigeration system of claim 1 wherein the evaporator block includes a recess, the evaporator further comprising a temperature probe extending into the recess of the evaporator block.

13. The refrigeration system of claim 1 wherein the evaporator housing further comprises a desiccant slot for receiving a desiccant bag therein, the housing further including a desiccant slot cover providing access to the desiccant slot without removing the evaporator housing from the circuit board to allow for the replacement of the desiccant bag during operation of the refrigeration system.

14. The refrigeration system of claim 1 further comprising:

- a refrigeration unit supplying expanded refrigerant to the evaporator block through a wall in the evaporator housing via a refrigerant line and a refrigerant return line, the refrigeration unit includes regulating means

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for regulating the temperature of the refrigerant being passed to the evaporator block;
a temperature probe extending into a recess of the evaporator block; and
a controller for regulating the refrigeration unit in response to the temperature sensed by the temperature probe.

15. The refrigeration system of claim 14 wherein the regulating means includes at least one of a variable speed compressor and a hot gas bypass valve, the hot gas bypass valve allowing gas exiting the compressor to bypass a condenser within the refrigeration unit.

16. The refrigeration system of claim 14 wherein said controller employs a PID control algorithm.

17. The refrigeration system of claim 14 further comprising:
a heater on a second side of the circuit board opposite the logic module, the heater comprising a heat spreader plate in thermal communication with the plated through holes of the circuit board, a heat source in thermal communication with the heat spreader plate, and a temperature sensor sensing the temperature of the heat plate,
wherein the controller also regulating the heat source in response to the temperature sensed by the temperatures sensor.

18. A refrigeration and condensation control system for a computer system logic module, the logic module being mounted to a first side of a circuit board, the system comprising:
a heater on a second side of the circuit board opposite the logic module, the heater being in thermal communication via solid-to-solid conduction with plated through holes of the circuit board.

19. The system of claim 18 wherein the heater comprises a heat spreader plate in thermal communication with the plated through holes of the circuit board and a heat source in thermal communication with the heat spreader plate.

20. The system of claim 19 wherein the heat source comprises a heat cartridge disposed in a recess of the heat spreader plate.

21. The system of claim 19 wherein the heater includes two independent heat sources, each capable of providing sufficient heat to the circuit board such that no part of the circuit board exposed to ambient air is permitted to cool to a temperature below the local dew point.

22. The system of claim 19 further comprising an evaporator housing enclosing said logic module and sealed to the first side of said circuit board;
wherein the heater includes a through-hole perpendicular to a plane in which the circuit board is disposed, the through-hole being aligned with a through-hole in the circuit board and positioned directly under the logic module, the system further comprising:
a source of dry pressurized air; and
an air line extending from said source of dry pressurized air to said through-hole.

23. The system of claim 22 wherein said source of dry pressurized air includes a source of pressurized air providing pressurized air to a desiccant canister, the desiccant canister containing desiccant for absorbing moisture in the air.

24. The system of claim 22 wherein the air line comprises a capillary tube.

25. The system of claim 19 wherein the heater further comprises a temperature sensor sensing the temperature of the heat spreader plate, the system further comprising:

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a controller regulating the heat source in response to the temperature sensed by the temperature sensor.

26. A refrigeration and condensation control system for cooling a logic module mounted to a circuit board, the system comprising:
an evaporator housing enclosing said logic module and sealed to said circuit board;
an evaporator block inside said evaporator housing in thermal communication with the logic module;
said circuit board having a through-hole directly under the logic module for admitting dry pressurized air.

27. The system of claim 26 further comprising a source of dry pressurized air, and a air line connecting said source of dry pressurized air to said through-hole in the circuit board.

28. The system of claim 27 wherein said air line comprises a capillary tube of sufficient length as to greatly restrict the flow of air through said air line even when a seal of the evaporator housing is broken.

29. A refrigeration and condensation control system for cooling a logic module mounted to a first side of a circuit board, the system comprising:
an evaporator block in thermal communication with the logic module, the evaporator block having two serpentine paths that are separate and distinct;
a temperature probe having two independent thermistors positioned within a recess formed in the evaporator block;
a first refrigeration unit in fluid communication with a first of said two serpentine paths;
a second refrigeration unit in fluid communication with a second of said two serpentine paths, wherein either the first refrigeration unit or the second refrigeration unit are capable of sufficiently cooling the logic module to maintain its temperature below ambient;
an evaporator housing enclosing said evaporator block and the logic module, the evaporator housing being sealed to the circuit board;
a heater mounted to a second side of a circuit board, the heater comprising a heat plate in thermal communication with plated through-holes of the circuit board, two heat sources in thermal communication with the heat plate, and two temperature sensors measuring the temperature of the heat plate;

A first controller and a second controller, each of first controller and the second controller receiving respective inputs from respective thermistors of the temperature probe and from respective temperature sensors of the heater, each controller also comprising outputs for controlling a respective one of the refrigeration units and a respective one of the heat sources, said first and second controllers also being in communication with a cage controller, said first and second controllers being programmed to control a temperature of the evaporator block in response to instructions from the cage controller.

30. The system of claim 29 wherein each of said refrigeration units are interchangeable and provide redundancy backup capabilities for ensuring that the logic module remains at a desired temperature in case one of the first and second refrigeration units fail.

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